

APPENDIX
VERSION WITH MARKINGS TO SHOW CHANGES MADE

IN THE CLAIMS:

The claims are amended as follows:

7. (Thrice Amended) An electronic assembly comprising:
a back electrode electronic part comprising:
a main body including a circuit, and
electrodes [provided] arranged on a back surface portion of said electronic part and
connected to said circuit, wherein said electrodes are arranged into groups of electrodes at
portions of the electrode arrangement;
said groups of electrodes includes said electrodes having a substantially same potential
level when said circuit operates;
said electronic assembly further comprising:
a printed circuit board having substrate electrodes corresponding to said electrodes
provided for said electronic part, wherein one of said substrate electrodes as a first substrate
electrode is provided for each of said groups of electrodes, and said substrate electrodes as
second substrate electrodes other than said first substrate electrodes are provided for said
electrodes of said electronic part other than in said groups of electrodes; and

Amendment Under 37 C.F.R. § 1.111
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solder bumps including first solder bumps connected with said groups of electrodes and said first substrate electrodes and second solder bumps connected with said second substrate electrodes and said electrodes of said electronic part other than said groups of electrodes.

Claims 13-20 are added as new claims.